

## 深圳市佑驰电子有限公司

### Specification for Approval

| 产品名称: | 一体系列电感            |  |
|-------|-------------------|--|
| 规格型号: | HCMA-0630-R25-M02 |  |
| 产品编号: |                   |  |
| 日 期:  | 2020-03-16        |  |

- 1、本承认书的内容更改需经过双方确认,任一方单独的修改均视为无效。
- 2、本承认书在送达客户后,请给予承认并即签回, 如无签 回下订单 的, 我司有权以此 承认 书标准生产, 并表示购买方默认许可。

| 审核 | 制作 |
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| 批准 | 申核 | 检验 |
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|     | REVISION    |            |          |         |          |  |  |
|-----|-------------|------------|----------|---------|----------|--|--|
| REV | DESCRIPTION | DATE       | DESIGNED | CHECKED | APPROVED |  |  |
| A0  | 文件建立        | 2020/03/16 | 吕秀秀      | Bowen   | Darren   |  |  |
|     |             |            |          |         |          |  |  |
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# High Current, Power Inductors HCMA-0630-R25-M02 Power Choke





#### **Description**

- Halogen Free
- 125°C maximum total temperature operation
- 7.6x6.8x 3.0mm maximum surface mount package
- · Powder iron core material
- · Magnetically shielded, low EMI
- High current carrying capacity, Low core losses
- · RoHS compliant

#### **Applications**

- Voltage Regulator Module (VRM)
- · Multi-phase regulators
- · Point-of-load modules
- · Smart phone POL modules
- SSD modules
- Notebook regulators
- Battery power systems
- · Graphics cards
- Data networking and storage systems

#### **Environmental Data**

- •Storage temperature range: -55°C to +125 °C
- Operating temperature range: -55°C to +125°C (ambient plus self-temperature rise)
- •Solder reflow temperature: J-STD-020 compliant

| Description |        |          |                   |   |                                       |                  |       |                      |       |           |     |
|-------------|--------|----------|-------------------|---|---------------------------------------|------------------|-------|----------------------|-------|-----------|-----|
|             |        | НСМА     | HCMA-0630-R25-M02 |   |                                       | M02 0.25μH ±20 % |       |                      | ±20 % |           |     |
|             |        |          | Model             |   | Inductance Value Inductance Tolerance |                  |       | Inductance Tolerance |       |           |     |
|             |        |          |                   |   | Global Part Number                    |                  |       |                      |       |           |     |
| Н           | С      | М        | Α                 | 0 | 6                                     | 3                | 0     | R                    | 2     | 5         | M02 |
|             |        |          |                   |   |                                       |                  |       |                      |       |           |     |
|             | Produc | ct Serie | s                 |   | Dimensions                            |                  | Induc | Inductance Value     |       | Tolerance |     |



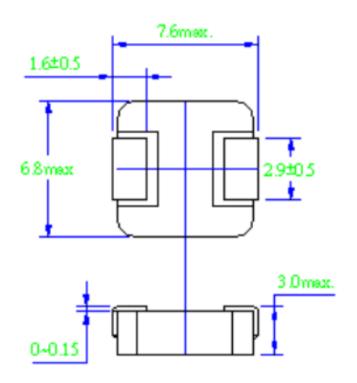
|                   | Inductance         | DC Resistance |      | <b>Heating Rating Current</b> | Saturation Current |
|-------------------|--------------------|---------------|------|-------------------------------|--------------------|
| Part No.          | L0 (µH)            | DCR (mΩ)      |      | Idc (A)                       | Isat (A)           |
|                   | ±20 %, 100 kHz, 1V | TYP.          | MAX. | TYP.                          | TYP.               |
| HCMA-0630-R25-M02 | 0.25               | 2.8           | 3.0  | 22.0                          | 37.0               |

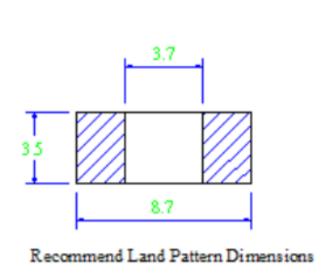
#### **Notes**

- 1. All test data is referenced to 25 °C ambient
- 2. Operating temperature range 55 °C to + 125 °C
- 3. Idc(A):DC current (A) that will cause an approximate ΔT of 40 °C(reference ambient temperature is 25 °C)
- 4. Isat(A):DC current (A) that will cause L0 to drop approximately 30 %
- 5. The part temperature (ambient + temp rise) should not exceed 125 °C under worst case operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.



#### •Dimensions-mm



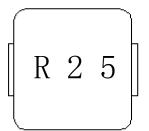


#### Marking

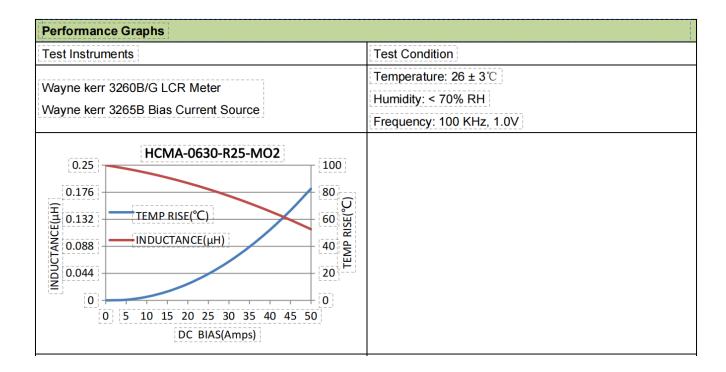
The inductor is marked with a 3-digit code

Example - -0.25→R25

Note: Using Ink for marking



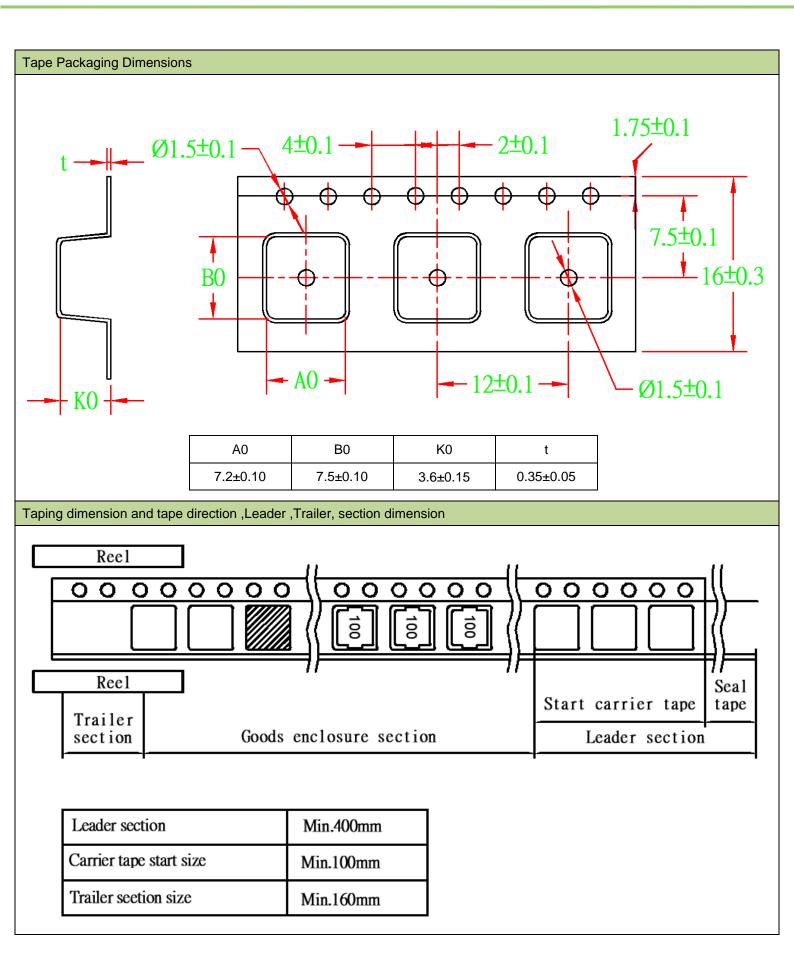




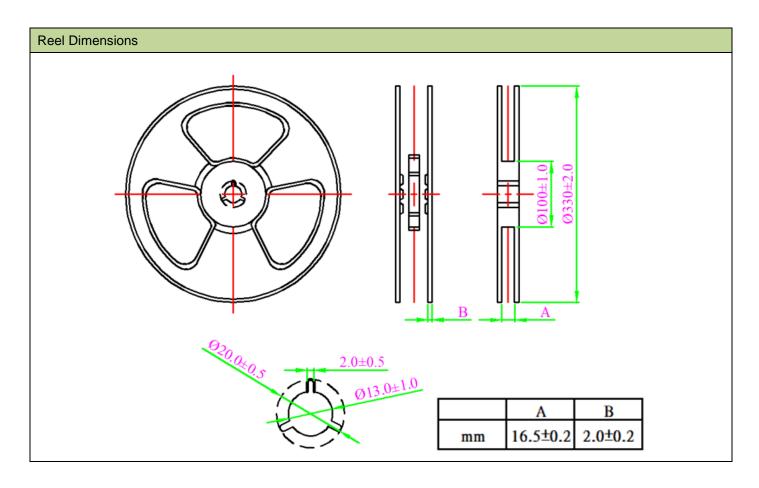


| Mecha | anical Reliability            |   |  |  |
|-------|-------------------------------|---|--|--|
| No.   | Item                          | Specification and Requirement   | Test Method  |  |
| 1     | Solderability                 | The surface of terminal immersed shall be minimum of 95% covered with a new coating of solder | Retention time: 245 $\pm$ 5 $^{\circ}$ C for 5+0/-0.5seconds;  |  |
| 2     | Resistance to Soldering Heat  | Change from an initial value Inductance:within ± 10%  | Retention time: within 30 seconds 255 $\pm5$ $^{\circ}\mathrm{C}$ , Three Times;   |  |
| 3     | Terminal Strength             | No electrode detachment   | No electrode detachment should be found when the device is pushed is two directions of X and Y with the force of 17.7N for 60 seconds after soldering between copper plate and the electrodes;                                     |  |
| 4     | Vibration                     | Inductance change: Within ± 10% Without mechanical damage such as break                       | <ol> <li>Vibration frequency: (10 Hz to 2000 Hz to 10Hz) in 20 minutes as a period;</li> <li>Vibration time: Period cycled for four hours in each of 3 mutual perpendicular directions.</li> <li>Amplitude: 1.5 mm max.</li> </ol> |  |
| 5     | Mechanical Shock              | Inductance change: Within ± 10% Without mechanical damage such as break                       | Peak value: 100 G, Duration of pulse: 6ms     3 times in each positive and negative direction of 3 mutual perpendicular directions;  |  |
| 6     | Substrate Bending             | Inductance change: Within ± 10% Without distinct damage in appearance                         | 1.Bending speed is 0.5mm/sec, 2.While the bending width reaches 2mm, keep it for 60 sec  |  |
| Endur | ance Reliability              |   |  |  |
| No.   | Item                          | Specification and Requirement   | Test Method  |  |
| 7     | Thermal Shock                 | Inductance change: Within ± 10% Without distinct damage in appearance                         | Repeat 1000 cycles as follow: (-55 $\pm$ 2 $^{\circ}$ C; 30 $\pm$ 3 min) $\rightarrow$ (+125 $^{\circ}$ C $\pm$ 2 $^{\circ}$ C , 30 $\pm$ 3 min)   |  |
| 8     | Low Temperature Storage       | Inductance change: Within ± 10% Without distinct damage in appearance                         | Store temperature: -55 $\pm$ 2 $^{\circ}$ C, 1000 + 4 / -0 hours;  |  |
| 9     | High Temperature Storage      | Inductance change: Within ± 10% Without distinct damage in appearance                         | Store temperature: $+125^{\circ}\text{C} \pm 2^{\circ}\text{C}$ , $1000 + 4 \text{ / } -0$ hours;  |  |
| 10    | High Temperature<br>&Humidity | Inductance change: Within ± 10% Without distinct damage in appearance                         | 85℃85%RH ,1000+4/-0 hours;   |  |





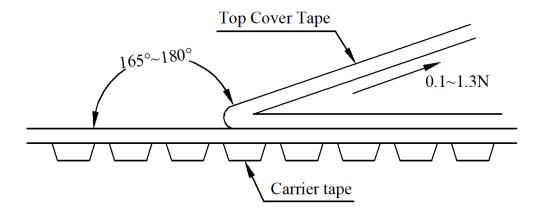




• Peel force of top cover tape

The peel speed shall be about 300mm/minute

The peel force of top cover tape shall be between 0.1 to 1.3 N



Numbers of taping
 1500pieces/reel